

## TrenchT2™ HiperFET™ **Power MOSFET**

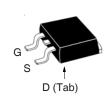
# **IXFA130N10T2** IXFP130N10T2

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



100V 130A I<sub>D25</sub>  $10.1 \mathrm{m}\Omega$  $\leq$ R<sub>DS(on)</sub>





Symbol	Test Conditions	<b>Maximum Ratings</b>		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 175°C	100	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}C$ to 175°C, $R_{GS} = 1M\Omega$	100	V	
$V_{gss}$	Continuous	±20	V	
V <sub>GSM</sub>	Transient	±30	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C (Chip Capability)	130	A	
I <sub>L(RMS)</sub>	External Lead Current Limit	120	Α	
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	300	Α	
I <sub>A</sub>	T <sub>C</sub> = 25°C	65	A	
E <sub>as</sub>	$T_{c} = 25^{\circ}C$	800	mJ	
dV/dt	$I_{S} \leq I_{DM}, V_{DD} \leq V_{DSS}, T_{J} \leq 175^{\circ}C$	20	V/ns	
$P_{D}$	T <sub>C</sub> = 25°C	360	W	
 T <sub>J</sub>		-55 +175	°C	
T <sub>JM</sub>		175	°C	
T <sub>stg</sub>		-55 +175	°C	
T,	Maximum Lead Temperature for Soldering	g 300	°C	
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C	
F <sub>c</sub>	Mounting Force (TO-263)	1065 / 2.214.6	N/lb	
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10	Nm/lb.in	
Weight	TO-263	2.5	g	
	TO-220	3.0	g	

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V <sub>GSS</sub> V <sub>GSM</sub>	Continuous Transient	±20 ±30	V
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E <sub>as</sub>	$T_{c} = 25^{\circ}C$	800	mJ
dV/dt	$I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}},  V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 175^{\circ}\mathrm{C}$	20	V/ns
$P_{D}$	$T_{c} = 25^{\circ}C$	360	W
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Weight	TO-263 TO-220	2.5 3.0	g g

TO-22 (IXFP)			Tô	San Contract of the Contract o
	G <sub>D</sub>	D (T	† Tab)	
	_	_		

G = Gate	D	=	Drain
S = Source	Tab	=	Drain

### **Features**

- · International Standard Packages
- 175°C Operating Temperature
- · High Current Handling Capability
- Fast Intrinsic Rectifier
- Dynamic dV/dt Rated
- Low  $R_{DS(on)}$

#### **Advantages**

- · Easy to Mount
- Space Savings
- · High Power Density

### **Applications**

- DC-DC Converters
- Battery Charges
- Switch-Mode and Resonant-Mode **Power Supplies**
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- · High Speed Power Switching Applications

Symbol (T <sub>J</sub> = 25°C U	Test Conditions Unless Otherwise Specified)	Chara Min.	acteristi Typ.	c Value: Max.	S
BV <sub>DSS</sub>	$V_{GS} = 0V, I_{D} = 250\mu A$	100			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 1 \text{mA}$	2.0		4.5	V
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$			10	μΑ
	$T_J = 150^{\circ}C$			500	μΑ
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 65A, Notes 1 & 2$			10.1	mΩ



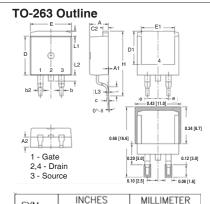
<b>Symbo</b> (T <sub>J</sub> = 25		Test Conditions nless Otherwise Specified)	Char Min.	acteristic Typ.	c Values Max.
g <sub>fs</sub>		$V_{DS} = 10V, I_{D} = 60A, Note 1$	35	58	S
C <sub>iss</sub>	)			6600	pF
C <sub>oss</sub>	}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		640	pF
C <sub>rss</sub>	J			133	pF
t <sub>d(on)</sub>	)	Resistive Switching Times		16	ns
t,	(	$V_{GS} = 10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 65A$		38	ns
$\mathbf{t}_{d(off)}$	(	$R_{\rm G} = 3.3\Omega$ (External)		24	ns
t <sub>f</sub>	J	Tig = 0.032 (External)		25	ns
$\mathbf{Q}_{g(on)}$	)			130	nC
$\mathbf{Q}_{gs}$	}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 65A$		35	nC
$\mathbf{Q}_{\mathrm{gd}}$	J			42	nC
R <sub>thJC</sub>					0.42 °C/W
R <sub>thCS</sub>		TO-220		0.50	°C/W

#### Source-Drain Diode

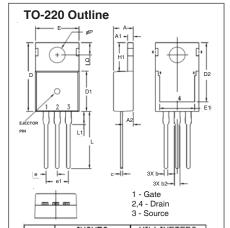
Symbol Test Conditions Character (T, = 25°C Unless Otherwise Specified) Min.			cteristic	Value: Max.	
I <sub>s</sub>	V <sub>GS</sub> = 0V			130	A
I <sub>SM</sub>	Repetitive, Pulse Width Limited by T <sub>JM</sub>			520	Α
V <sub>SD</sub>	$I_F = 65A$ , $V_{GS} = 0V$ , Note 1			1.3	V
t <sub>rr</sub>	I <sub>2</sub> = 65A, V <sub>22</sub> = 0V.			100	ns
I <sub>RM</sub>	$I_F = 65A, V_{GS} = 0V,$ $-di/dt = 100A/\mu s, V_B = 50V$		4.8		Α
Q <sub>RM</sub>	$-\alpha i/\alpha t = 100A/\mu s$ , $v_R = 50V$		156		nC

Notes: 1. Pulse test,  $t \le 300 \mu s$ ; duty cycle,  $d \le 2\%$ .

2. On through-hole packages,  $R_{\mathrm{DS(on)}}$  Kelvin test contact location must be 5mm or less from the package body.



SYM	INCH	HES	MILLIN	<b>METER</b>
SIM	MIN	MAX	MIN	MAX
Α	.170	.185	4.30	4.70
Α1	.000	.008	0.00	0.20
A2	.091	.098	2.30	2.50
Ь	.028	.035	0.70	0.90
b2	.046	.060	1.18	1.52
С	.018	.024	0.45	0.60
C2	.049	.060	1.25	1.52
D	.340	.370	8.63	9.40
D1	.300	.327	7.62	8.30
Ε	.380	.410	9.65	10.41
E1	.270	.330	6.86	8.38
е	.100	BSC	2.54	BSC
Н	.580	.620	14.73	15.75
L	.075	.105	1.91	2.67
L1	.039	.060	1.00	1.52
L2	_	.070	_	1.77
L3	.010	BSC	0.254	BSC



SYM	INC	HES	MILLIM	ETERS
2114	MIN	MAX	MIN	MAX
Α	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
Ь	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
С	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
Ε	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
е	.100	) BSC	2.54	BSC
e1	.200	) BSC	5.08	BSC
H1	.244	.268	6.20	6.80
L	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØΡ	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



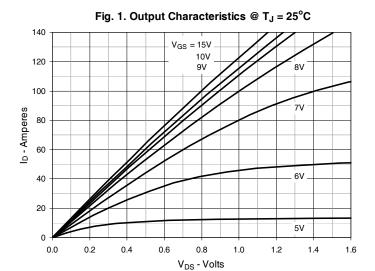
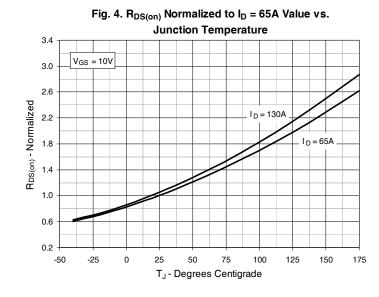
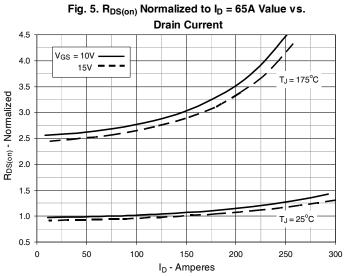
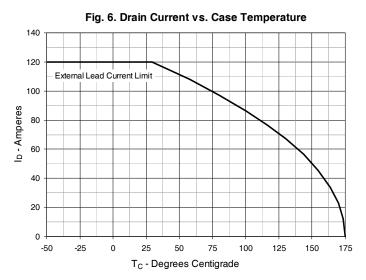


Fig. 2. Extended Output Characteristics @ T<sub>J</sub> = 25°C 350  $V_{GS} = 15V$ 10V 300 9V 250 lo - Amperes 200 150 100 50 5V 8 10 12 6 V<sub>DS</sub> - Volts

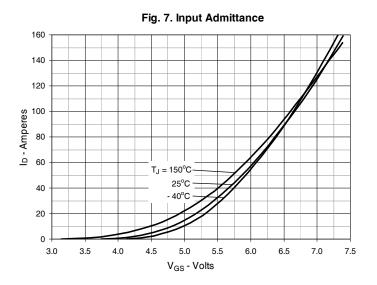
Fig. 3. Output Characteristics @ T<sub>J</sub> = 150°C 140 V<sub>GS</sub> = 15V 10V 120 8V 100 7V ID - Amperes 60 6V 40 20 5V 0 1.0 2.0 0.0 0.5 1.5 V<sub>DS</sub> - Volts

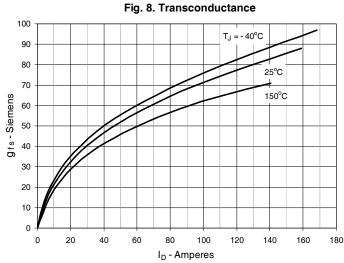


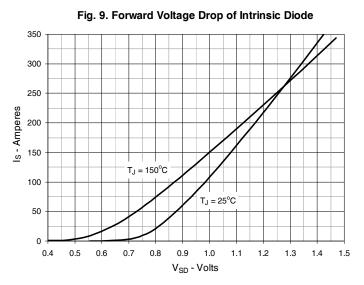


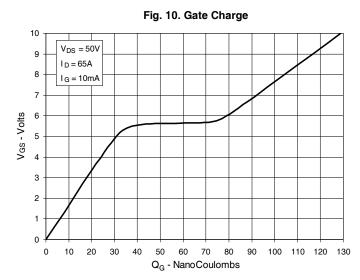


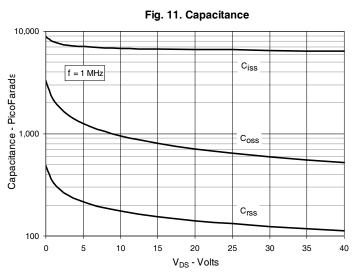


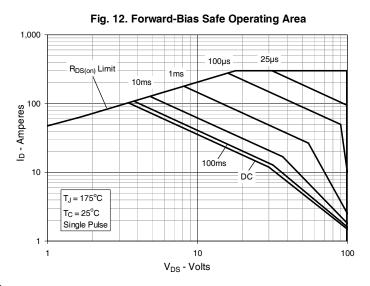












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Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

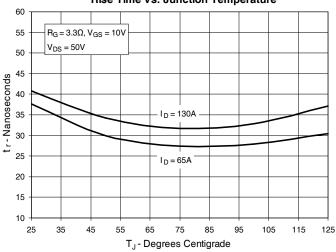


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

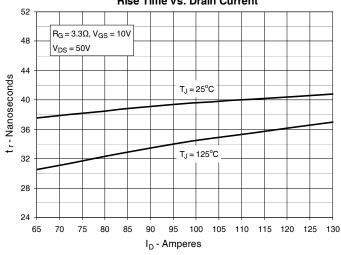


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

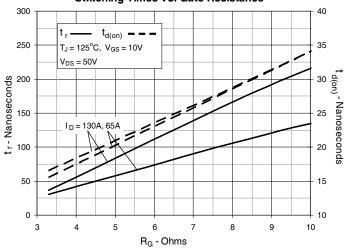


Fig. 16. Resistive Turn-off

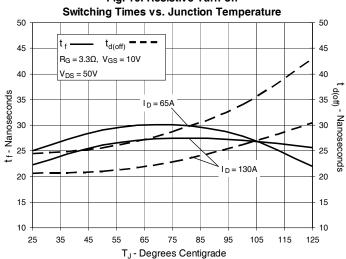


Fig. 17. Resistive Turn-off

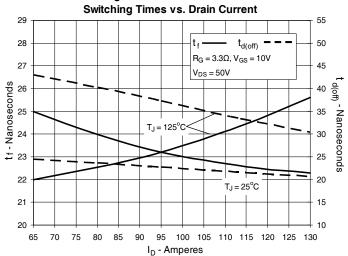
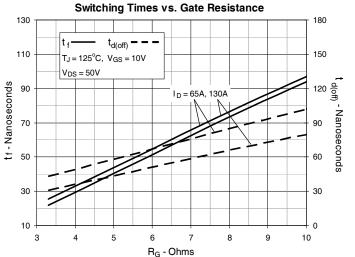


Fig. 18. Resistive Turn-off





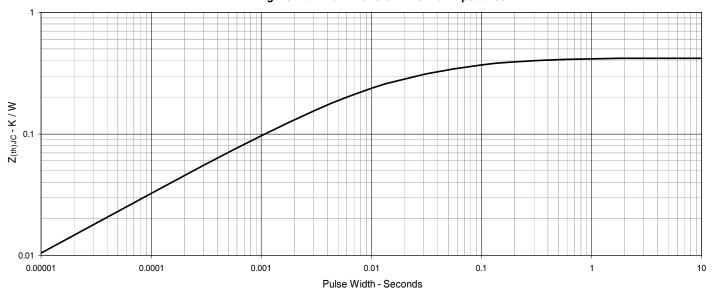


Fig. 19. Maximum Transient Thermal Impedance

